3.3V ECL Differential Clock D Flip-Flop

The MC100LVEL51 is a differential clock D flip-flop with reset. The device is functionally equivalent to the EL51 device, but operates from a 3.3 V supply. With propagation delays and output transition times essentially equal to the EL51, the LVEL51 is ideally suited for those applications which require the ultimate in AC performance at 3.3 V V_{CC} .

The reset input is an asynchronous, level triggered signal. Data enters the master portion of the flip-flop when the clock is LOW and is transferred to the slave, and thus the outputs, upon a positive transition of the clock. The differential clock inputs of the LVEL51 allow the device to be used as a negative edge triggered flip-flop.

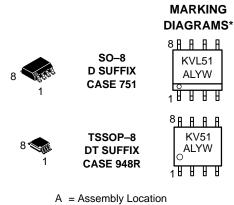
The differential input employs clamp circuitry to maintain stability under open input conditions. When left open, the CLK input will be pulled down to V_{EE} and the \overline{CLK} input will be biased at $V_{CC}/2$.

- 475 ps Propagation Delay
- 2.8 GHz Toggle Frequency
- ESD Protection: >4 KV HBM, >200 V MM
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: V_{CC}= 3.0 V to 3.8 V with V_{EE}= 0 V
- NECL Mode Operating Range: V_{CC}= 0 V with V_{EE}= -3.0 V to -3.8 V
- Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1 For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL–94 code V–0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count = 114 devices



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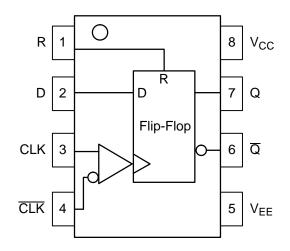
L = Wafer Lot Y = Year W = Work Week

*For additional information, see Application Note AND8002/D

ORDERING INFORMATION

Device	Package	Shipping
MC100LVEL51D	SO–8	98 Units / Rail
MC100LVEL51DR2	SO–8	2500 / Reel
MC100LVEL51DT	TSSOP-8	98 Units / Rail
MC100LVEL51DTR2	TSSOP-8	2500 / Reel

LOGIC DIAGRAM AND PINOUT ASSIGNMENT



PIN DESCRIPTION

PIN	FUNCTION
CLK, <u>CLK</u>	ECL Differential Clock Input
Q, <u>Q</u>	ECL Differential Output
D	ECL D Input
R	ECL Reset Input
V _{CC}	Positive Supp;y
V_{EE}	Negative Supply

TRUTH TABLE

D	R	CLK	Q
L	L	Z	ΓΗΓ
H	L	Z	
X	H	X	

Z = LOW to HIGH Transition X = Don't Care

MAXIMUM RATINGS (Note 1.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	V
V_{EE}	NECL Mode Power Supply	$V_{CC} = 0 V$		8 to 0	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$V_{I} \leq V_{CC}$ $V_{I} \geq V_{EE}$	6 to 0 6 to 0	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
ТА	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W °C/W
θJC	Thermal Resistance (Junction to Case)	std bd	8 SOIC	41 to 44 \pm 5%	°C/W
θ_{JA}	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction to Case)	std bd	8 TSSOP	41 to 44 \pm 5%	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

1. Maximum Ratings are those values beyond which device damage may occur.

			–40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Мах	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		30	35		30	35		32	37	mA
V _{OH}	Output HIGH Voltage (Note 2.)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V _{OL}	Output LOW Voltage (Note 2.)		1605	1745	1490	1595	1680	1490	1595	1680	mV
V _{IH}	Input HIGH Voltage (Single Ended)	2135		2420	2135		2420	2135		2420	mV
V _{IL}	Input LOW Voltage (Single Ended)	1490		1825	1490		1825	1490		1825	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential) (Note 3.) Vpp < 500 mV Vpp ≧ 500 mV	1.2 1.4		3.0 3.0	1.1 1.3		3.0 3.0	1.1 1.3		3.0 3.0	V V
I _{IH}	Input HIGH Current			150			150			150	μΑ
IIL	Input LOW Current Others	0.5 600			0.5 600			0.5 600			μΑ μΑ

LVPECL DC CHARACTERISTICS V_{CC}= 3.3 V; V_{EE}= 0.0 V (Note 1)

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary ± 0.3 V.

2. Outputs are terminated through a 50 ohm resistor to V_{CC}-2 volts.

3. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP} min and 1 V.

			–40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		30	35		30	35		32	37	mA
V _{OH}	Output HIGH Voltage (Note 2.)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V _{OL}	Output LOW Voltage (Note 2.)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V _{IH}	Input HIGH Voltage (Single Ended)	-1165		-880	-1165		-880	-1165		-880	mV
V _{IL}	Input LOW Voltage (Single Ended)	-1810		-1475	-1810		-1475	-1810		-1475	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 3.) Vpp < 500 mV Vpp ≧ 500 mV	-2.1 -1.9		-0.3 -0.3	-2.2 -2.0		-0.3 -0.3	-2.2 -2.0		-0.3 -0.3	V V
I _{IH}	Input HIGH Current			150			150			150	μΑ
IIL	Input LOW Current Others CLK	0.5 600			0.5 600			0.5 600			μΑ μΑ

LVNECL DC CHARACTERISTICS V_{CC}= 0.0 V; V_{EE}= -3.3 V (Note 1.)

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary ± 0.3 V.

2. Outputs are terminated through a 50 ohm resistor to V_{CC} -2 volts.

3. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP} min and 1 V.

		–40°C			25°C				85°C			
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Мах	Unit
f _{max}	Maximum Toggle Frequency		2.7			2.8			2.9			GHz
t _{PLH} t _{PHL}	Propagation Delay to Output	CLK R	330 340	465 455	510 540	340 350	475 765	520 550	370 390	530 510	550 590	ps
t _S	Setup Time		150	0		150	0		150	0		ps
t _H	Hold Time		200	100		200	100		200	100		ps
t _{RR}	Reset Recovery		350	200		350	200		350	200		ps
t _{PW}	Minimum Pulse Width	CLK Reset	400 500			400 500			400 500			ps
t _{JITTER}	Cycle-to-Cycle Jitter			TBD			TBD			TBD		ps
V _{PP}	Input Swing (Note 2.)		150		1000	150		1000	150		1000	mV
t _r t _f	Output Rise/Fall Times Q (20% – 80%)		120		320	120		320	120		320	ps

AC CHARACTERISTICS $\text{V}_{\text{CC}}\text{=}~3.3~\text{V};~\text{V}_{\text{EE}}\text{=}~0.0~\text{V}~~\text{or}~~\text{V}_{\text{CC}}\text{=}~0.0~\text{V};~\text{V}_{\text{EE}}\text{=}~-3.3~\text{V}~(\text{Note 1.})$

V_{EE} can vary ±0.3 V.
 V_{PP}(min) is minimum input swing for which AC parameters are guaranteed.

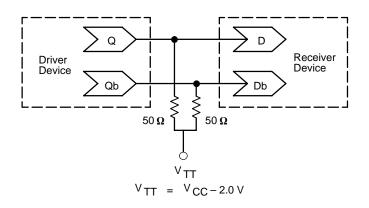


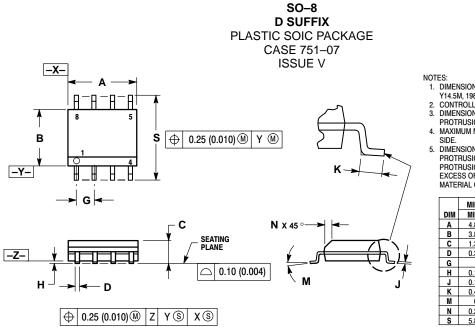
Figure 1. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

Resource Reference of Application Notes

AN1404	_	ECLinPS Circuit Performance at Non–Standard $V_{\mbox{\scriptsize IH}}$ Levels
AN1405	_	ECL Clock Distribution Techniques
AN1406	_	Designing with PECL (ECL at +5.0 V)
AN1503	_	ECLinPS I/O SPICE Modeling Kit
AN1504	_	Metastability and the ECLinPS Family
AN1560	_	Low Voltage ECLinPS SPICE Modeling Kit
AN1568	_	Interfacing Between LVDS and ECL
AN1596	_	ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
AN1650	_	Using Wire–OR Ties in ECLinPS Designs
AN1672	_	The ECL Translator Guide
AND8001	_	Odd Number Counters Design
AND8002	_	Marking and Date Codes

AND8020 _ Termination of ECL Logic Devices

PACKAGE DIMENSIONS

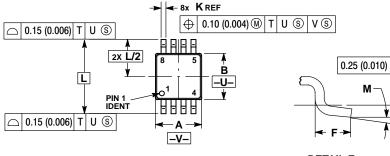


NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

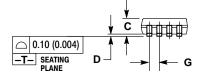
	MILLIN	IETERS	INC	HES	
DIM	MIN	MIN MAX		MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
C	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.2	7 BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
Μ	0 °	8 °	0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

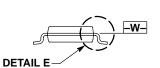
PACKAGE DIMENSIONS

TSSOP-8 DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**









NOTES:

- DIES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED

- FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE. 5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY. 6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.114	0.122
В	2.90	3.10	0.114	0.122
C	0.80	1.10	0.031	0.043
D	0.05	0.15	0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65	BSC	0.026	BSC
K	0.25	0.40	0.010	0.016
L	4.90	BSC	0.193	
Μ	0 °	6 °	0°	6 °

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